

Note that the A3952SB (DIP) and the A3952SLB (SOIC) are electrically identical and share a common terminal number assignment.

ABSOLUTE MAXIMUM RATINGS

Load Supply Voltage, V _{BB} 50 V
Output Current, I _{OUT}
$(t_{W} \le 20 \ \mu s) \dots \pm 3.5 \ A$
(Continuous) ±2.0 A
Logic Supply Voltage, V _{CC} 7.0 V
Logic Input Voltage Range,
V _{IN} 0.3 V to V _{cc} + 0.3 V
Sense Voltage, V _{SENSE} 1.5 V
Reference Voltage, V _{REF} 15 V

P_D **See Graph** Operating Temperature Range,

Package Power Dissipation,

T_S -55°C to +150°C

Output current rating may be limited by duty cycle, ambient temperature, heat sinking and/or forced cooling. Under any set of conditions, do not exceed the specified current rating or a junction temperature of +150°C.

* Fault conditions that produce excessive junction temperature will activate device thermal shutdown circuitry. These conditions can be tolerated but should be avoided.

Designed for bidirectional pulse-width modulated current control of inductive loads, the A3952S— is capable of continuous output currents to ± 2 A and operating voltages to 50 V. Internal fixed off-time PWM current-control circuitry can be used to regulate the maximum load current to a desired value. The peak load current limit is set by the user's selection of an input reference voltage and external sensing resistor. The fixed OFF-time pulse duration is set by a user-selected external RC timing network. Internal circuit protection includes thermal shutdown with hysteresis, transient suppression diodes, and crossover-current protection. Special power-up sequencing is not required.

With the ENABLE input held low, the PHASE input controls load current polarity by selecting the appropriate source and sink driver pair. The MODE input determines whether the PWM current-control circuitry operates in a slow current-decay mode (only the selected sink driver switching) or in a fast current-decay mode (selected source and sink switching). A user-selectable blanking window prevents false triggering of the PWM current control circuitry. With the ENABLE input held high, all output drivers are disabled. A sleep mode is provided to reduce power consumption when inactive.

When a logic low is applied to the BRAKE input, the braking function is enabled. This overrides ENABLE and PHASE to turn OFF both source drivers and turn ON both sink drivers. The brake function can be safely used to dynamically brake brush dc motors.

The A3952S– is supplied in a choice of three power packages. In all package styles, the batwing is at ground potential and needs no isolation. These devices are also available for operation from -40°C to +125°C. To order, change the suffix from 'S–' to 'K–'.

FEATURES

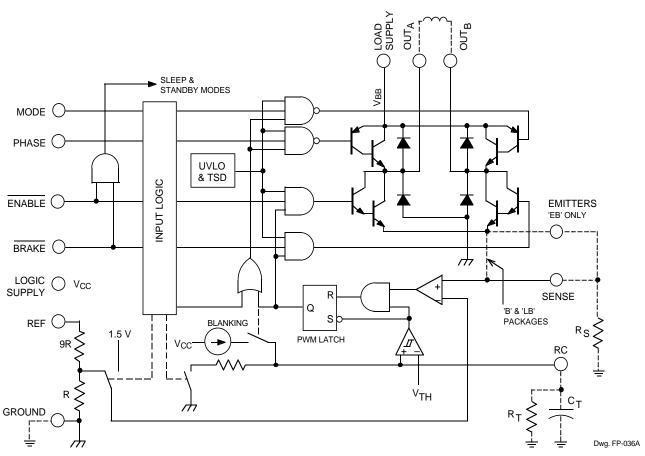
- ±2 A Continuous Output Current Rating
- 50 V Output Voltage Rating
- Internal PWM Current Control
- Fast and Slow Current-Decay Modes
- Sleep (Low Current Consumption) Mode
- Internal Transient Suppression Diodes
- Under-Voltage Lockout
- Internal Thermal Shutdown Circuitry
- Crossover-Current Protection

Always order by complete part number:

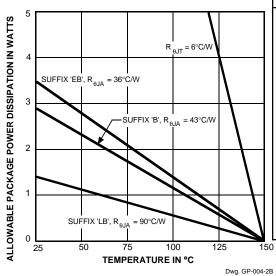
Part Number	Package	$R_{\scriptscriptstyle{\thetaJA}}$	$R_{\theta JT}$
A3952SB	16-Pin DIP	43°C/W	6.0°C/W
A3952SEB	28-Lead PLCC	36°C/W	6.0°C/W
A3952SLB	16-Lead SOIC	90°C/W	6.0°C/W



FUNCTIONAL BLOCK DIAGRAM



TRUTH TABLE



BRAKE	ENABLE	PHASE	MODE	OUTA	OUT _B	DESCRIPTION
Н	Н	Х	Н	Z	Z	Sleep Mode
Н	Н	X	L	Z	Z	Standby, Note 1
Н	L	Н	Н	Н	L	Forward,
						Fast-Decay Mode
Н	L	Н	L	Н	L	Forward,
						Slow-Decay Mode
H	L	L	Н	L	Н	Reverse,
						Fast-Decay Mode
H	L	L	L	L	Н	Reverse,
						Slow-Decay Mode
L	Х	X	Н	L	L	Brake,
						Fast-Decay Mode
L	Х	Χ	L	L	L	Brake, No Current
						Control, Note 2

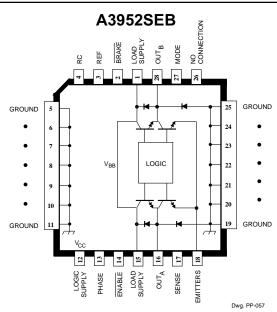
X = Irrelevant

Z = High Impedance (source and sink both OFF)

NOTES: 1. In

- 1. Includes active pull-offs for power outputs.
- 2. Includes internal default $\mathbf{V}_{\text{sense}}$ level for over-current protection.





ELECTRICAL CHARACTERISTICS at T_A = +25°C, V_{BB} = 50 V, V_{CC} = 5.0 V, V_{BRAKE} = 2.0 V, V_{SENSE} = 0 V, RC = 20 k Ω /1000 pF to Ground (unless noted otherwise).

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Drivers	•		'			
Load Supply Voltage Range	V_{BB}	Operating, $I_{OUT} = \pm 2.0 \text{ A}$, $L = 3 \text{ mH}$	V _{cc}	_	50	V
Output Leakage Current	I _{CEX}	$V_{OUT} = V_{BB}$	_	<1.0	50	μΑ
		V _{OUT} = 0 V	_	<-1.0	-50	μΑ
Output Saturation Voltage	V _{CE(SAT)}	Source Driver, I _{OUT} = -0.5 A	_	0.9	1.2	V
		Source Driver, I _{OUT} = -1.0 A	_	1.0	1.4	V
		Source Driver, I _{OUT} = -2.0 A	_	1.2	1.8	V
		Sink Driver, I _{OUT} = +0.5 A	_	0.9	1.2	V
		Sink Driver, I _{OUT} = +1.0 A	_	1.0	1.4	V
		Sink Driver, I _{OUT} = +2.0 A	_	1.3	1.8	V
Clamp Diode Forward Voltage	V _F	I _F = 0.5 A	_	1.0	1.4	V
(Source or Sink)		I _F = 1.0 A	_	1.1	1.6	V
		I _F = 2.0 A	_	1.4	2.0	V
Load Supply Current	I _{BB(ON)}	V _{ENABLE} = 0.8 V	_	2.9	6.0	mA
(No Load)	I _{BB(OFF)}	V _{ENABLE} = 2.0 V, V _{MODE} = 0.8 V	_	3.1	6.5	mA
		V _{BRAKE} = 0.8 V	_	3.1	6.5	mA
	I _{BB(SLEEP)}	V _{ENABLE} = V _{MODE} = 2.0 V	_	<1.0	50	μА
		•		Con	tinued ne	xt page

			Limits			
Characteristic	Symbol	Test Conditions		Тур.	Max.	Units
Control Logic	•		•			
Logic Supply Voltage Range	V _{cc}	Operating	4.5	5.0	5.5	V
Logic Input Voltage	V _{IN(1)}		2.0	_	_	V
	V _{IN(0)}		-	_	0.8	V
Logic Input Current	I _{IN(1)}	V _{IN} = 2.0 V	_	<1.0	20	μΑ
	I _{IN(0)}	V _{IN} = 0.8 V	-	<-2.0	-200	μΑ
Reference Voltage Range	V _{REF}	Operating	0	_	15	V
Reference Input Current	I _{REF}	V _{REF} = 2.0 V	25	40	55	μΑ
Reference Voltage Divider Ratio	_	V _{REF} = 15 V	9.5	10.0	10.5	_
Comparator Input Offset Voltage	V _{IO}	V _{REF} = 0 V	-	±1.0	±10	mV
PWM RC Fixed OFF Time	t _{off}	$C_{T} = 1000 \text{ pF}, R_{T} = 20 \text{ k}\Omega$	18	20	22	μs
PWM Minimum ON Time	t _{on(min)}	$C_T = 820 \text{ pF}, R_T \ge 12 \text{ k}\Omega$	-	1.7	3.0	μs
		$C_T = 1200 \text{ pF}, R_T \ge 12 \text{ k}\Omega$	_	2.5	3.8	μs
Propagation Delay Time	t _{pd}	$I_{OUT} = \pm 2.0 \text{ A}$, 50% E_{IN} to 90% E_{OUT} Transition:				
		ENABLE ON to Source ON	-	2.9	_	μs
		ENABLE OFF to Source OFF	-	0.7	-	μs
		ENABLE ON to Sink ON	-	2.4	-	μs
		ENABLE OFF to Sink OFF	-	0.7	_	μs
		PHASE Change to Source ON	-	2.9	-	μs
		PHASE Change to Source OFF	-	0.7	-	μs
		PHASE Change to Sink ON	-	2.4	-	μs
		PHASE Change to Sink OFF	-	0.7	-	μs
	t _{pd(pwm)}	Comparator Trip to Sink OFF	_	0.8	1.5	μs
Thermal Shutdown Temperature	T_J		_	165	_	°C
Thermal Shutdown Hysteresis	ΔT_J		-	15	_	°C
UVLO Disable Threshold	V _{CC(UVLO)}		3.15	3.50	3.85	V
UVLO Hysteresis	$\Delta V_{CC(UVLO)}$		300	400	500	mV
Logic Supply Current	I _{CC(ON)}	V _{ENABLE} = 0.8 V, V _{BRAKE} = 2.0 V	_	20	30	mA
(No Load)	I _{CC(OFF)}	V _{ENABLE} = 2.0 V, V _{MODE} = 0.8 V	_	12	18	mA
	I _{CC(BRAKE)}	V _{BRAKE} = 0.8 V	_	26	40	mA
	I _{CC(SLEEP)}	$V_{\text{ENABLE}} = V_{\text{MODE}} = V_{\text{BRAKE}} = 2.0 \text{ V}$	_	3.0	5.0	mA

NOTES: 1. Typical Data is for design information only.
2. Each driver is tested separately.
3. Negative current is defined as coming out of (sourcing) the specified device terminal.



FUNCTIONAL DESCRIPTION

INTERNAL PWM CURRENT CONTROL DURING FORWARD AND REVERSE OPERATION

The A3952S– contains a fixed OFF-time pulse-width modulated (PWM) current-control circuit that can be used to limit the load current to a desired value. The value of the current limiting (I_{TRIP}) is set by the selection of an external current sensing resistor ($R_{\rm S}$) and reference input voltage ($V_{\rm REF}$). The internal circuitry compares the voltage across the external sense resistor to one tenth the voltage on the REF input terminal, resulting in a function approximated by

$$I_{TRIP} = V_{REF}/(10R_S)$$
.

In forward or reverse mode the current-control circuitry limits the load current. When the load current reaches I_{TRIP} , the comparator resets a latch to turn OFF the selected sink driver (in the slow-decay mode) or selected sink and source driver pair (in the fast-decay mode). In slow-decay mode, the selected sink driver is disabled; the load inductance causes the current to recirculate through the source driver and flyback diode (see figure 1). In fast-decay mode, the selected sink and source driver pair are disabled; the load inductance causes the current to flow from ground to the load supply via the ground clamp and flyback diodes.

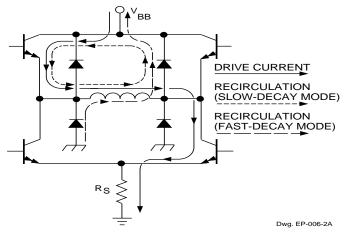


Figure 1 — Load-Current Paths

The user selects an external resistor (R_T) and capacitor (C_T) to determine the time period ($t_{off} = R_T C_T$) during which the drivers remain disabled (see "RC Fixed OFF Time" below). At the end of the $R_T C_T$ interval, the drivers are re-enabled allowing the load current to increase again. The PWM cycle repeats, maintaining the load current at the desired value (see figure 2).

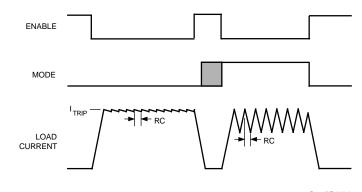


Figure 2 — Fast and Slow Current-Decay Waveforms

INTERNAL PWM CURRENT CONTROL DURING BRAKE MODE OPERATION

The brake circuit turns OFF both source drivers and turns ON both sink drivers. For dc motor applications, this has the effect of shorting the motor's back-EMF voltage, resulting in current flow that brakes the motor dynamically. However, if the back-EMF voltage is large, and there is no PWM current limiting, then the load current can increase to a value that approaches a locked rotor condition. To limit the current, when the I_{TRIP} level is reached, the PWM circuit disables the conducting sink driver. The energy stored in the motor's inductance is then discharged into the load supply causing the motor current to decay.

As in the case of forward/reverse operation, the drivers are re-enabled after a time given by $t_{\rm off} = R_{\rm T}C_{\rm T}$ (see "RC Fixed OFF Time" below). Depending on the back-EMF voltage (proportional to the motor's decreasing speed), the load current again may increase to $I_{\rm TRIP}$. If so, the PWM cycle will repeat, limiting the load current to the desired value.

Brake Operation - MODE Input High

During braking, when the MODE input is high, the current limit can be approximated by

$$I_{TRIP} = V_{REF}/(10R_S)$$
.

CAUTION: Because the kinetic energy stored in the motor and load inertia is being converted into current, which charges the V_{BB} supply bulk capacitance (power supply output and decoupling capacitance), care must be taken to ensure the capacitance is sufficient to absorb the energy without exceeding the voltage rating of any devices connected to the motor supply.

Brake Operation - MODE Input Low

During braking, with the MODE input low, the peak current limit defaults internally to a value approximated by

$$I_{TRIP} = 1.5 \text{ V/R}_{S}$$

In this mode, the value of R_S determines the I_{TRIP} value independent of V_{REF}. This is useful in applications with differing run and brake currents and no practical method of varying V_{REF}.

Choosing a small value for $R_{\rm S}$ essentially disables the current limiting during braking. Therefore, care should be taken to ensure that the motor's current does not exceed the absolute maximum ratings of the device. The braking current can be measured by using an oscilloscope with a current probe connected to one of the motor's leads.

RC Fixed OFF Time

The internal PWM current control circuitry uses a one shot to control the time the driver(s) remain(s) OFF. The one shot time, $t_{\rm off}$ (fixed OFF time), is determined by the selection of an external resistor (R_T) and capacitor (C_T) connected in parallel from the RC terminal to ground. The fixed OFF time, over a range of values of C_T = 820 pF to 1500 pF and R_T = 12 k Ω to 100 k Ω , is approximated by

$$t_{off} = R_T C_T$$
.

When the PWM latch is reset by the current comparator, the voltage on the RC terminal will begin to decay from approximately 3 volts. When the voltage on the RC terminal reaches approximately 1.1 volt, the PWM latch is set, thereby re-enabling the driver(s).

RC Blanking

In addition to determining the fixed OFF-time of the PWM control circuit, the $\mathrm{C_T}$ component sets the comparator blanking time. This function blanks the output of the comparator when the outputs are switched by the internal current control circuitry (or by the PHASE, BRAKE, or ENABLE inputs). The comparator output is blanked to prevent false over-current detections due to reverse recovery currents of the clamp diodes, and/or switching transients related to distributed capacitance in the load.

During internal PWM operation, at the end of the $t_{\rm off}$ time, the comparator's output is blanked and $C_{\rm T}$ begins to be charged from approximately 1.1 V by an internal current source of approximately 1 mA. The comparator output remains blanked until the voltage on $C_{\rm T}$ reaches approximately 3.0 volts.

Similarly, when a transition of the PHASE input occurs, C_T is discharged to near ground during the crossover delay time (the crossover delay time is present to prevent simultaneous conduction of the source and sink drivers). After the crossover delay, C_T is charged by an internal current source of approximately 1 mA. The comparator output remains blanked until the voltage on C_T reaches approximately 3.0 volts.

Similarly, when the device is disabled via the ENABLE input, C_T is discharged to near ground. When the device is re-enabled, C_T is charged by the internal current source. The comparator output remains blanked until the voltage on C_T reaches approximately 3.0 V.

For applications that use the internal fast-decay mode PWM operation, the minimum recommended value is $C_{\rm T}$ = 1200 pF ± 5 %. For all other applications, the minimum recommended value is $C_{\rm T}$ = 820 pF ± 5 %. These values ensure that the blanking time is sufficient to avoid false trips of the comparator under normal operating conditions. For optimal regulation of the load current, the above values for $C_{\rm T}$ are recommended and the value of $R_{\rm T}$ can be sized to determine $t_{\rm off}$. For more information regarding load current regulation, see below.

LOAD CURRENT REGULATION WITH THE INTERNAL PWM CURRENT-CONTROL CIRCUITRY

When the device is operating in slow-decay mode, there is a limit to the lowest level that the PWM current-control circuitry can regulate load current. The limitation is the minimum duty cycle, which is a function of the user-selected value of $t_{\rm off}$ and the maxuimum value of the minimum ON-time pulse, $t_{\rm on(min)}$, that occurs each time the PWM latch is reset. If the motor is not rotating, as in the case of a stepper motor in hold/detent mode, or a brush dc motor when stalled or at startup, the worst-case value of current regulation can be approximated by

$$I_{(AV)} \approx \frac{\left[\left(V_{BB} - V_{SAT(source+sink)} \right) \bullet t_{on(min)} max \right] - \left[1.05 \left(V_{SAT(sink)} + V_D \right) \bullet t_{off} \right]}{1.05 \left(t_{on(min)} max + t_{off} \right) \bullet R_{LOAD}}$$

where $t_{\rm off} = R_{\rm T}C_{\rm T}$, $R_{\rm LOAD}$ is the series resistance of the load, $V_{\rm BB}$ is the load/motor supply voltage, and $t_{\rm on(min)}$ max is specified in the electrical characteristics table. When the motor is rotating, the back EMF generated will influence the above relationship. For brush dc motor applications, the current regulation is improved. For stepper motor applications when the motor is rotating, the effect is more complex. A discussion of this subject is included in the section on stepper motors under "Applications".



The following procedure can be used to evaluate the worst-case slow-decay internal PWM load current regulation in the system:

Set V_{REF} to 0 volts. With the load connected and the PWM current control operating in slow-decay mode, use an oscilloscope to measure the time the output is low (sink ON) for the output that is chopping. This is the typical minimum ON time $(t_{on(min)} typ)$ for the device. C_T then should be increased until the measured value of $t_{on(min)}$ is equal to $t_{on(min)} max) = 3.0~\mu s$ as specified in the electrical characteristics table. When the new value of C_T has been set, the value of R_T should be decreased so the value for $t_{off} = R_T \cdot C_T$ (with the artificially increased value of C_T) is equal to 105% of the nominal design value. The worst-case load current regulation then can be measured in the system under operating conditions.

In applications utilizing both fast- and slow-decay internal PWM modes, the performance of the slow-decay current regulation should be evaluated per the above procedure and a $t_{on(min)}$ max of 3.8 μ s. This corresponds to a C_T value of 1200 pF, which is required to ensure sufficient blanking during fast-decay internal PWM.

LOAD CURRENT REGULATION WITH EXTERNAL PWM OF THE PHASE AND ENABLE INPUTS

The PHASE and ENABLE inputs can be pulse-width modulated to regulate load current. Typical propagation delays from the PHASE and ENABLE inputs to transitions of the power outputs are specified in the electrical characteristics table. If the internal PWM current control is used, then the comparator blanking function is active during phase and enable transitions. This eliminates false tripping of the over-current comparator caused by switching transients (see "RC Blanking" above).

ENABLE Pulse-Width Modulation

With the MODE input low, toggling the ENABLE input turns ON and OFF the selected source and sink drivers. The corresponding pair of flyback and ground clamp diodes conduct after the drivers are disabled, resulting in fast current decay. When the device is enabled, the internal current control circuitry will be active and can be used to limit the load current in a slow-decay mode.

For applications that PWM the ENABLE input, and desire that the internal current limiting circuit function in the fast-decay mode, the ENABLE input signal should be inverted and connected to the MODE input. This prevents the device from being switched into sleep mode when the ENABLE input is low.

PHASE Pulse-Width Modulation

Toggling the PHASE terminal determines/controls which sink/source pair is enabled, producing a load current that varies with the duty cycle and remains continuous at all times. This can have added benefits in bidirectional brush dc servo motor applications as the transfer function between the duty cycle on the phase input and the average voltage applied to the motor is more linear than in the case of ENABLE PWM control (which produces a discontinuous current at low current levels). See also, "DC Motor Applications" below.

SYNCHRONOUS FIXED-FREQUENCY PWM

The internal PWM current-control circuitry of multiple A3952S– devices can be synchronized by using the simple circuit shown in figure 3. A 555 IC can be used to generate the reset pulse/blanking signal (t_1) and the period of the PWM cycle (t_2). The value of t_1 should be a minimum of 1.5 μ s in slow-decay mode and 2 μ s in fast-decay mode. When used in this configuration, the R_T and C_T components should be omitted. The PHASE and ENABLE inputs should not be PWMed with this circuit configuration due to the absence of a blanking function synchronous with their transitions.

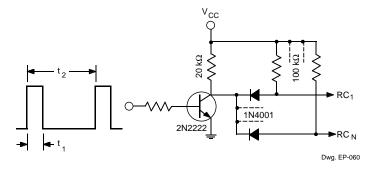


Figure 3 — Synchronous Fixed-Frequency Control Circuit

MISCELLANEOUS INFORMATION

A logic high applied to both the ENABLE and MODE terminals puts the device into a sleep mode to minimize current consumption when not in use.

An internally generated dead time prevents crossover currents that can occur when switching phase or braking.

Thermal protection circuitry turns OFF all drivers should the junction temperature reach 165°C (typical). This is intended only to protect the device from failures due to excessive junction temperatures and should not

imply that output short circuits are permitted. The hysteresis of the thermal shutdown circuit is approximately 15°C.

If the internal current-control circuitry is not used; the V_{REF} terminal should be connected to V_{CC} , the SENSE terminal should be connected to ground, and the RC terminal should be left floating (no connection).

An internal under-voltage lockout circuit prevents simultaneous conduction of the outputs when the device is powered up or powered down.

APPLICATION NOTES

Current Sensing

The actual peak load current (I_{OUTP}) will be greater than the calculated value of I_{TRIP} due to delays in the turn OFF of the drivers. The amount of overshoot can be approximated as

$$I_{OUTP} \approx \frac{\left(V_{BB} - \left[\left(I_{TRIP} \bullet R_{LOAD}\right) + V_{BEMF}\right]\right) \bullet t_{pd(pwm)}}{L_{LOAD}}$$

where V_{BB} is the load/motor supply voltage, V_{BEMF} is the back-EMF voltage of the load, R_{LOAD} and L_{LOAD} are the resistance and inductance of the load respectively, and $t_{pd(pwm)}$ is the propagation delay as specified in the electrical characteristics table.

The reference terminal has an equivalent input resistance of 50 k Ω ±30%. This should be taken into account when determining the impedance of the external circuit that sets the reference voltage value.

To minimize current-sensing inaccuracies caused by ground trace IR drops, the current-sensing resistor should have a separate return to the ground terminal of the device. For low-value sense resistors, the IR drops in the PCB can be significant and should be taken into account. The use of sockets should be avoided as their contact resistance can cause variations in the effective value of $R_{\rm S}. \label{eq:RS}$

Larger values of $R_{\rm S}$ reduce the aforementioned effects but can result in excessive heating and power loss in the sense resistor. The selected value of $R_{\rm S}$ must not cause the SENSE terminal absolute maximum voltage rating to be exceeded. The recommended value of $R_{\rm S}$ is in the range of

$$R_s = (0.375 \text{ to } 1.125)/I_{TRIP}$$
.

The current-sensing comparator functions down to ground allowing the device to be used in microstepping, sinusoidal, and other varying current profile applications.

Thermal Considerations

For reliable operation, it is recommended that the maximum junction temperature be kept as low as possible, typically 90°C to 125°C. The junction temperature can be measured by attaching a thermocouple to the batwing of the device and measuring the tab temperature, $T_{\rm T}$. The junction temperature can then be approximated by using the formula

$$T_{J} \approx T_{T} + (2 V_{F} I_{OUT} R_{\theta,IT})$$

where V_F is the clamp diode forward voltage and can be determined from the electrical specification table for the given level of I_{OUT} . The value for $R_{\theta JT}$ is given in the package thermal resistance table (page 1) for the appropriate package.

The power dissipation of the batwing packages can be improved by 20 to 30% by adding a section of printed circuit board copper (typically 6 to 18 square centimeters) connected to the batwing terminals of the device. See Application Note 29501.5, *Improving Batwing Power Dissipation*.

The thermal performance in applications with high load currents and/or high duty cycles can be improved by adding external diodes in parallel with the internal diodes. In internal PWM slow-decay applications, only the two top-side (flyback) diodes need be added. For internal fast-decay PWM, or external PHASE or ENABLE input PWM applications, all four external diodes should be added for maximum junction temperature reduction.



PCB Layout

The load supply terminal, V_{BB} , should be decoupled (>47 μ F electrolytic and 0.1 μ F ceramic capacitors are recommended) as close to the device as is physically practical. To minimize the effect of system ground I•R drops on the logic and reference input signals, the system ground should have a low-resistance return to the load supply voltage.

See also "Current Sensing" and "Thermal Considerations" above.

Fixed Off-Time Selection

With increasing values of $t_{\rm off}$, switching losses decrease, low-level load-current regulation improves, EMI is reduced, the PWM frequency will decrease, and ripple current will increase. The value of $t_{\rm off}$ can be chosen for optimization of these parameters. For applications where audible noise is a concern, typical values of $t_{\rm off}$ are chosen to be in the range of 15 to 35 μs .

Stepper Motor Applications

The MODE terminal can be used to optimize the performance of the device in microstepping/sinusoidal stepper motor drive applications. When the average load current is increasing, slow-decay mode is used to limit the switching losses in the device and iron losses in the motor.

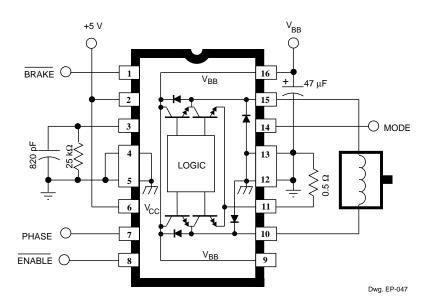
This also improves the maximum rate at which the load current can increase (as compared to fast decay) due to the slow rate of decay during $t_{\rm off}$. When the average load current is decreasing, fast-decay mode is used to regulate the load current to the desired level. This prevents tailing of the current profile caused by the back-EMF voltage of the stepper motor.

In stepper motor applications applying a constant current to the load, slow-decay mode PWM is used typically to limit the switching losses in the device and iron losses in the motor.

DC Motor Applications

In closed-loop systems, the speed of a dc motor can be controlled by PWM of the PHASE or ENABLE inputs, or by varying the REF input voltage ($V_{\rm REF}$). In digital systems (microprocessor controlled), PWM of the PHASE or ENABLE input is used typically thus avoiding the need to generate a variable analog voltage reference. In this case, a dc voltage on the REF input is used typically to limit the maximum load current.

In dc servo applications that require accurate positioning at low or zero speed, PWM of the PHASE input is selected typically. This simplifies the servo-control loop because the transfer function between the duty cycle on the PHASE input and the average voltage applied to the



Typical DC Servo Motor Application

motor is more linear than in the case of ENABLE PWM control (which produces a discontinuous current at low-current levels).

With bidirectional dc servo motors, the PHASE terminal can be used for mechanical direction control. Similar to when braking the motor dynamically, abrupt changes in the direction of a rotating motor produce a current generated by the back EMF. The current generated will depend on the mode of operation. If the internal current-control circuitry is not being used, then the maximum load current generated can be approximated by

$$I_{LOAD} = (V_{BEMF} + V_{BB})/R_{LOAD}$$

where V_{BEMF} is proportional to the motor's speed. If the internal slow-decay current-control circuitry is used, then the maximum load current generated can be approximated by $I_{\text{LOAD}} = V_{\text{BEMF}}/R_{\text{LOAD}}$. For both cases, care must be taken to ensure the maximum ratings of the device are not exceeded. If the internal fast-decay current-control circuitry is used, then the load current will regulate to a value given by

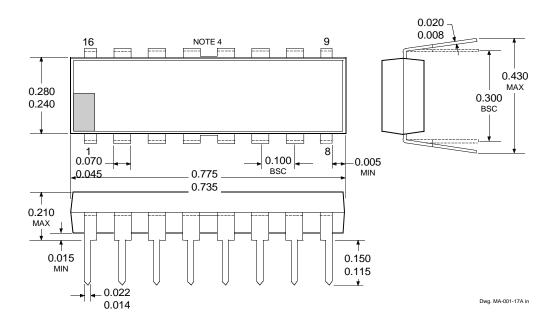
$$I_{LOAD} = V_{RFF}/(10 \cdot R_s)$$
.

CAUTION: In fast-decay mode, when the direction of the motor is changed abruptly, the kinetic energy stored in the motor and load inertia will be converted into current that charges the $V_{\rm BB}$ supply bulk capacitance (power supply output and decoupling capacitance). Care must be taken to ensure the capacitance is sufficient to absorb the energy without exceeding the voltage rating of any devices connected to the motor supply.

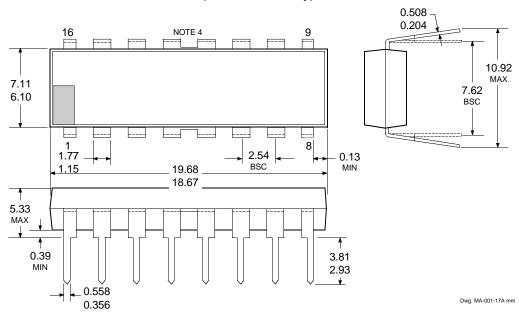
See also, the sections on brake operation under "Functional Description," above.

A3952SB

Dimensions in Inches (controlling dimensions)



Dimensions in Millimeters (for reference only)

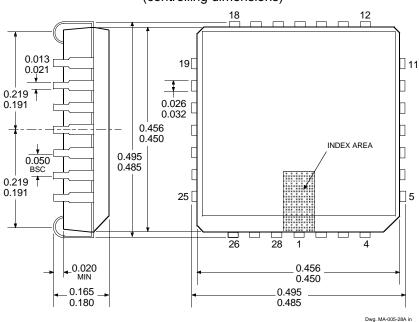


NOTES: 1. Leads 1, 8, 9, and 16 may be half leads at vendor's option.

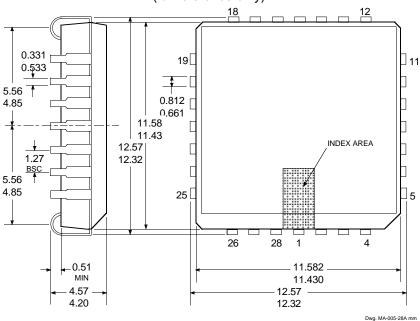
- 2. Webbed lead frame. Leads indicated are internally one piece.
- 3. Lead thickness is measured at seating plane or below.
- 4. Lead spacing tolerance is non-cumulative.
- 5. Exact body and lead configuration at vendor's option within limits shown.

A3952SEB

Dimensions in Inches (controlling dimensions)



Dimensions in Millimeters (for reference only)



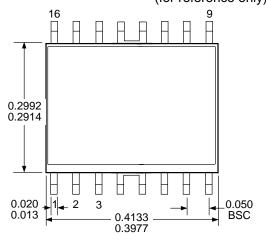
- NOTES: 1. Index is centered on "D" side.
 2. Webbed lead frame. Leads indicated are internally one piece.

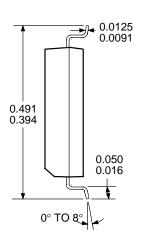
 - 3. Lead spacing tolerance is non-cumulative.4. Exact body and lead configuration at vendor's option within limits shown.
 - 5. Intended to meet new JEDEC Standard when that is approved.

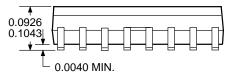


A3952SLB

Dimensions in Inches (for reference only)

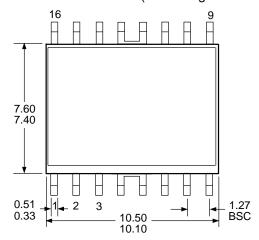


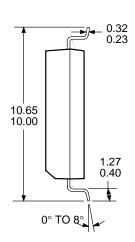


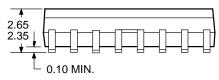


Dwg. MA-008-17 in

Dimensions in Millimeters (controlling dimensions)







Dwg. MA-008-17A mm

- NOTES: 1. Webbed lead frame. Leads indicated are internally one piece.
 2. Lead spacing tolerance is non-cumulative.
 3. Exact body and lead configuration at vendor's option within limits shown.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the design of its products.

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